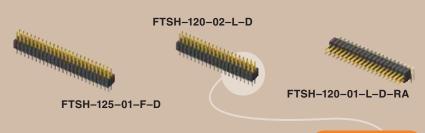




Mates with:

FLE, SFMC

FFSD, FFTP, CLP,



(1,27 mm) .050"

FTSH SERIES

(1,27 mm) .050"

THROUGH-HOLE MICRO HEADER

Impedance matched

for high speed

SPECIFICATIONS

For complete specifications see www.samtec.com?FTSH

Insulator Material:
Black Liquid
Crystal Polymer
Terminal Material:
Phosphor Bronze
Plating:
Sn or Au over
50µ" (1,27 µm) Ni
Current Rating (FTSH/CLP):
3.3 A per pin
(1 pin powered per row)
Operating Temp Range:
-55°C to +125°C
RoHS Compliant:

Processing: Lead-Free Solderable: Yes

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



For single



Applications (Mated with CLP Series)

Mates with socket strips or IDC cable

Through-hole, right angle or eight angle or eight

LOCKING CLIP

mating cycle with the FFSD. BOARD UTITUTE Specify -LC after tail option. Lead Style -01 and 10 pins/row minimum. 5-9 pins/row available in combination with keying shroud (-K).

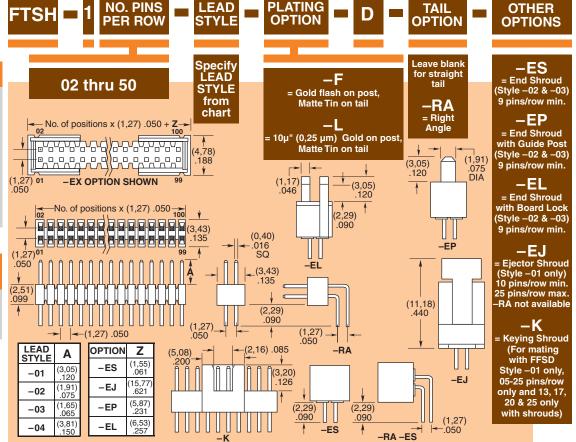
ALSO AVAILABLE (MOQ Required)

- Molded Pick & Place pads
- Other platings

Contact Samtec.

Note: See SFM/TFM for positive alignment feature.

Note: Some sizes, styles and options are non-standard, non-returnable.



Surface Mount

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM